# Design and Fabrication of Nb<sub>3</sub>Sn Cosθ Dipole Model at Fermilab

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### OUTLINE

## **Various Magnet Designs Investigated**

## **Dipole Model Fabrication**

**Cable Insulation and Wrapping** 

**Coil Winding, Curing and Measuring** 

**Coil Assembly and Reaction** 

**Coil Impregnation** 

## **Mechanical Analysis**

**Single Bore Design** 

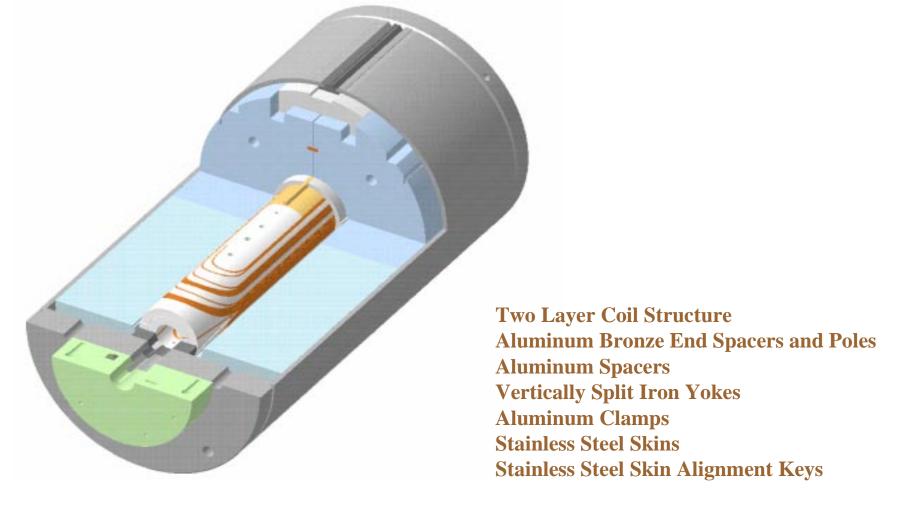
2-in-1 Designs

## **Summary**



# MAGNET DESIGNS

## (1) Single Bore Nb<sub>3</sub>Sn Cosθ Dipole Magnet Design





## Magnet Designs: Single Bore Design

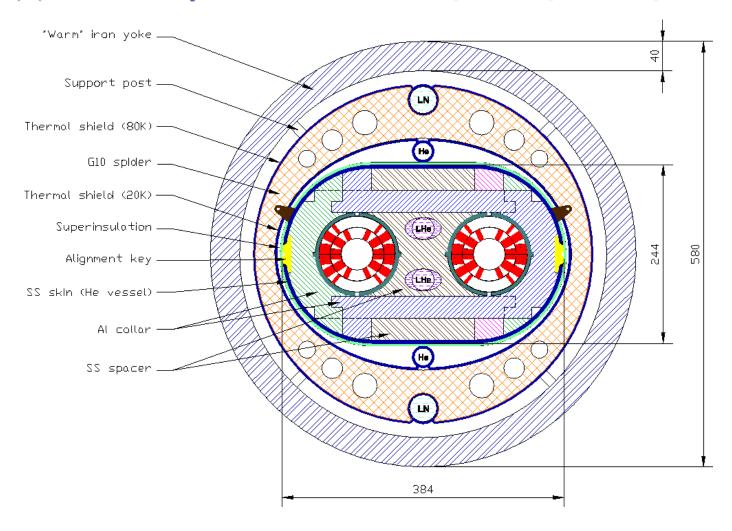
#### **Design Features**

- Nb<sub>3</sub>Sn Conductor Wind and React approach
- Ceramic Insulation with Ceramic Binder
- No interlayer Splice
- Simultaneous Reaction and Impregnation of two Half-Coils
- Spacers instead of Collars
- Vertical Gap between the two Iron Halves remains open
- Coil Prestress provided by aluminum clamps and Skin

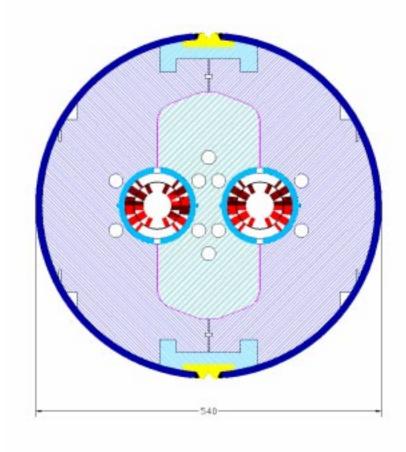
#### **Design Requirements**

- Coil azimuthal prestress not to exceed 150 MPa
- Coil should remain under compression at all stages of the magnet
- Insulation capable of withstanding high reaction temperature

## (2) 2 - in -1 Nb<sub>3</sub>Sn Cosθ Warm Iron Dipole Magnet Design



## (3) 2 - in -1 Nb<sub>3</sub>Sn Cosθ Cold Iron Dipole Magnet Design



Same Coil Block Structure was used for all three different Designs

Before going on to the mechanical analysis it is important to understand the coil fabrication procedure.



#### Coil Fabrication Procedure

#### **STEPS**

- 1. Cable Cleaning
- 2. Cable Insulation
- 3. Ceramic Binder Application and Curing
- 4. Inner Coil Winding
- 5. Application of binder to the Inner coil
- 6. Inner Coil Curing
- 7. Interlayer Insulation with Strip Heater
- 8. Outer Coil Winding on top of Inner coil
- 9. Application of binder to the Outer coil
- 10. Inner and Outer Coil Curing
- 11. Coil Assembly, Reaction and Impregnation

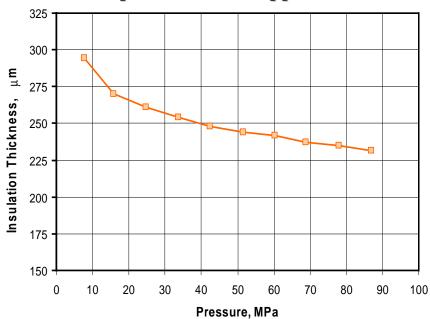


## Insulation Wrapping and Binder Application

#### **Insulation Wrapping Machine**



## Mean Insulation Thickness for 50% Overlap after Binder application

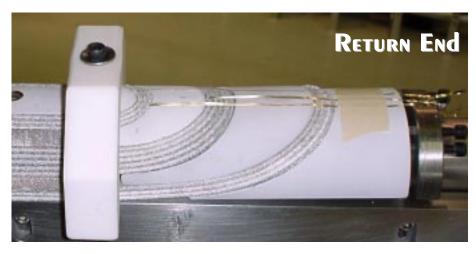


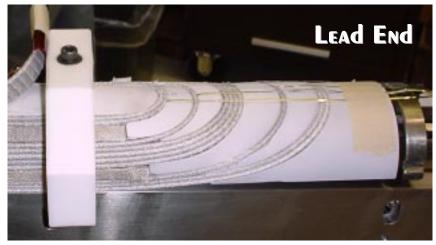


# INNER Coil Winding

# First Inner Coil before Curing









# INNER Coil Curing

## **Cured Coil**







Note: Coil was cured at 150 °C for 30 min. The curing pressure was 40 MPa



# Interlayer Insulation with Strip Heaters

## Tooling to make interlayer insulation



## Interlayer Insulation with Strip Heaters



Middle layer of insulation with heater strips

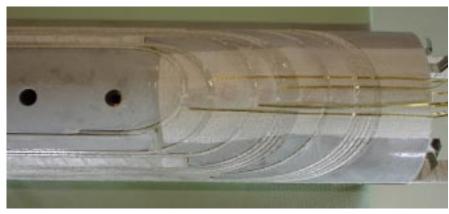




# **OUTER Coil Winding and Curing**

## After Curing



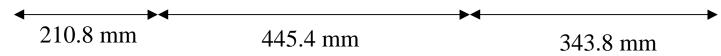






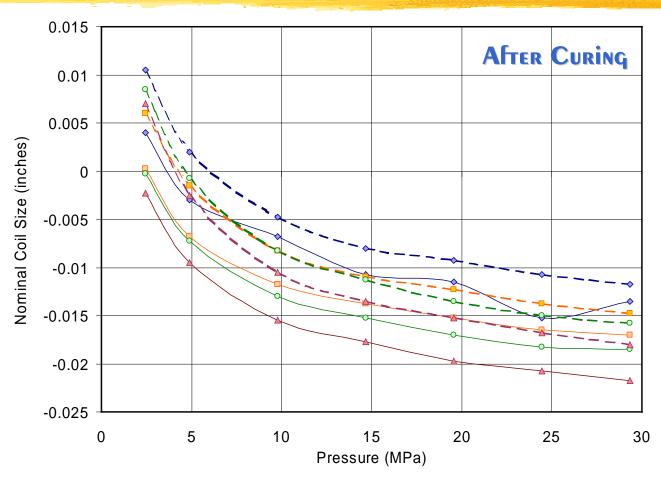
# Dipole Model: Two Half Coils







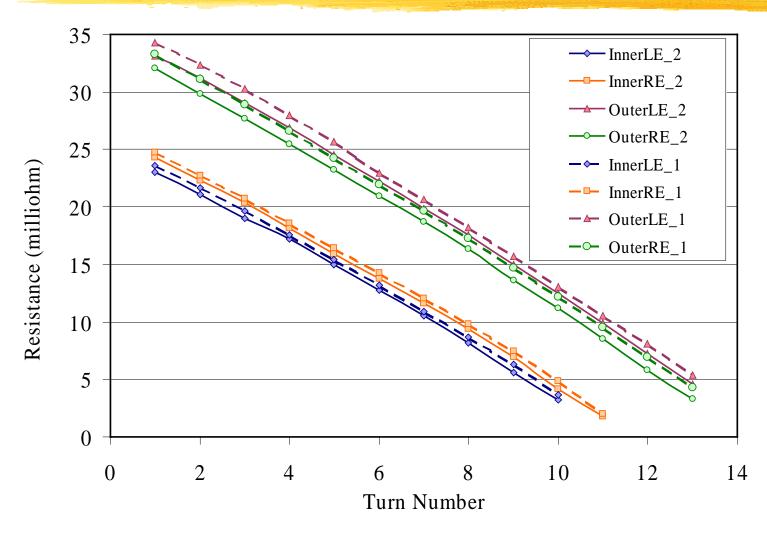
## Azimuthal Coil Size Measurements



Note: Measurements were taken at four different positions per half coil Dashed Lines Represent First Half Coil Solid Lines Represent Second Half Coil



## Turn - to - Turn Resistance Measurements

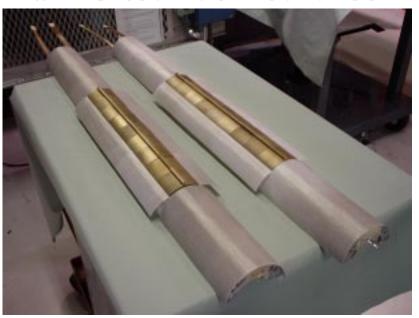


Note: Four Wire Measurement Technique with 0.1 mA current



## Coil Assembly and Reaction

#### Coils with Ground Insulation and Outer Pole Pieces



Coils Assembled in the Reaction Fixture



#### **CURRENT STATUS**

- The reaction fixture has been assembled and placed in a Retort
- The retort is now being pumped for vacuum
- Coil Reaction is expected to start by the end of the week and last for 12 days. Note that the peak temperature is 700 C

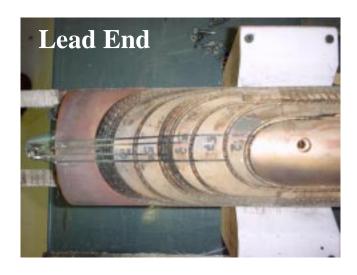


## REACTED HALF Coil: PRACTICE HALF COIL #2



Good Bonding Between the turns even after Reaction

We were able to handle the coil easily and even perform size measurements under pressure

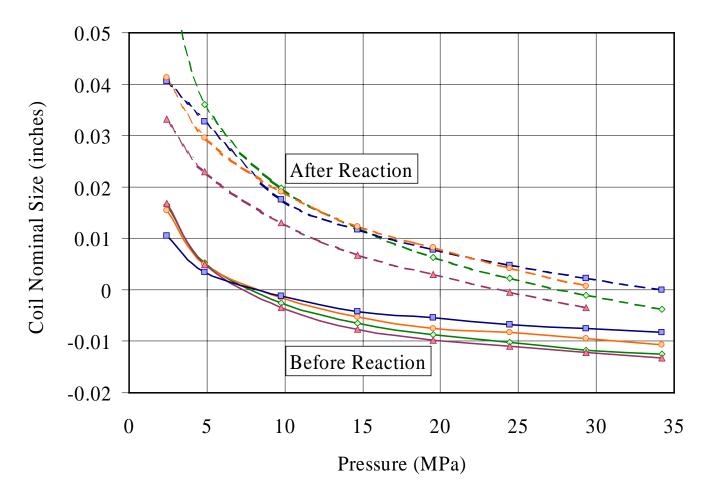






## Azimuthal Coil Size Measurements

## **Before and After Reaction: Practice Half Coil #2**





### Short Term Schedule

Practice Coil Impregnation: June 10, 2000

Coil Assembly and Reaction: June 15, 2000

Dipole Model - 1 Impregnation: July 10, 2000

Technological Model Assembly: July 10, 2000

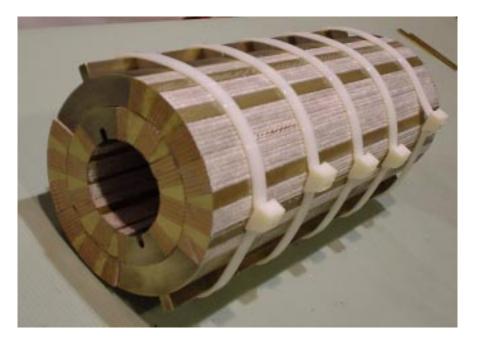
Dipole Model - 1 Assembly: August 15, 2000

Dipole Model - 1 Testing: End of August, 2000

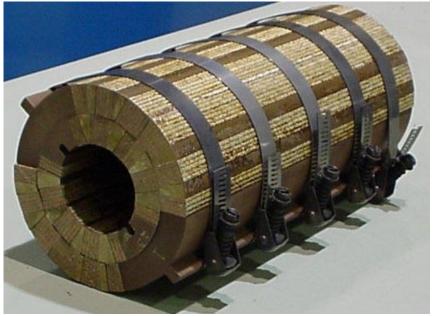


# Technological Model

#### **Model Before Reaction**



## **Model After Reaction**



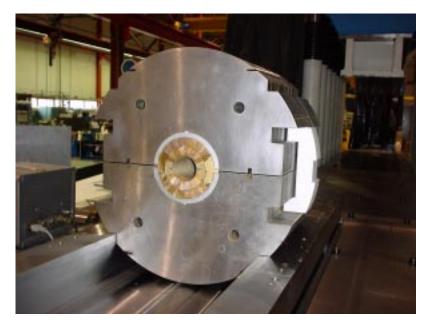


# Technological Model

## Model After Impregnation



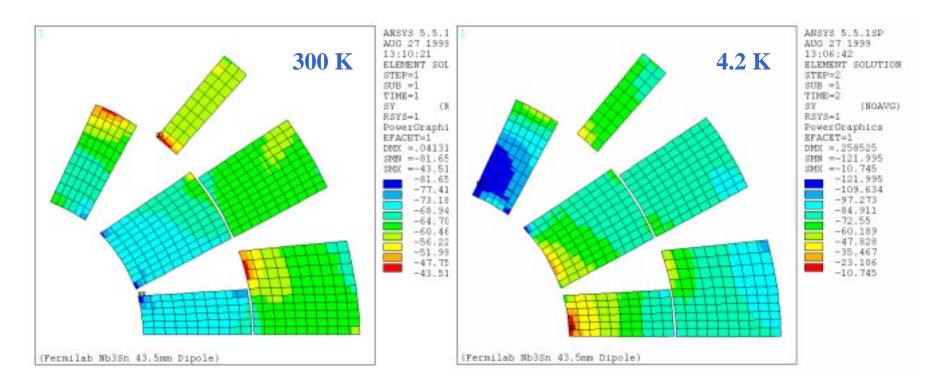
## Model with Yoke Assembly





## Mechanical Analysis

#### Coil Azimuthal Stress Distribution



- High prestress at midplane
- Low prestress at pole

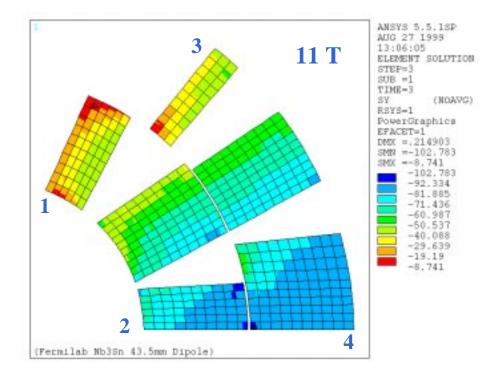


- Stress decreases at midplane
- Stress increases at pole



## **Mechanical Analysis**

#### Coil Azimuthal Stress Distribution



#### Peak Coil Azimuthal Stress, MPa

Coil	300 K		4.2 K		11 T		12 T	
position	$\sigma_{\theta}$	$\sigma_{r}$	$\sigma_{\theta}$	$\sigma_{\rm r}$	$\sigma_{\theta}$	$\sigma_{r}$	$\sigma_{\theta}$	$\sigma_{\mathbf{r}}$
1	69	2	122	0	9	0	-5	0
2	73	2	23	0	82	0	93	0
3	60	35	85	70	51	60	44	50
4	65	40	97	52	93	94	103	100

#### Peak Equivalent Stress, MPa

	300 K	4.2 K	11 T	12 T
Coil	80	121	100	104
Spacer	166	125	97	97
Yoke	110	110	133	133
Clamp	135	124	128	128
Skin	200	330	350	350

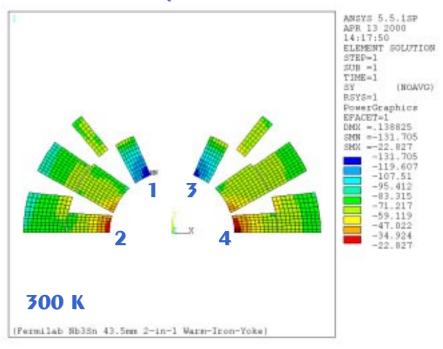


## Mechanical Analysis: 2 - in - 1 Design

#### **Coil Azimuthal Stress**

Coil Azimuthal Stress							
Coil	300 K	4.2 K	12 T				
Posiiton	<b>MPa</b>	MPa	<b>MPa</b>				
Warm Iron Yoke Design							
1	131	118	2.5				
2	23	-10	95				
3	131	118	2.5				
4	23	-10	121				
Cold Iron Yoke Design							
1	120	132	0				
2	60	0	68				
3	121	132	-3				
4	84	29	125				

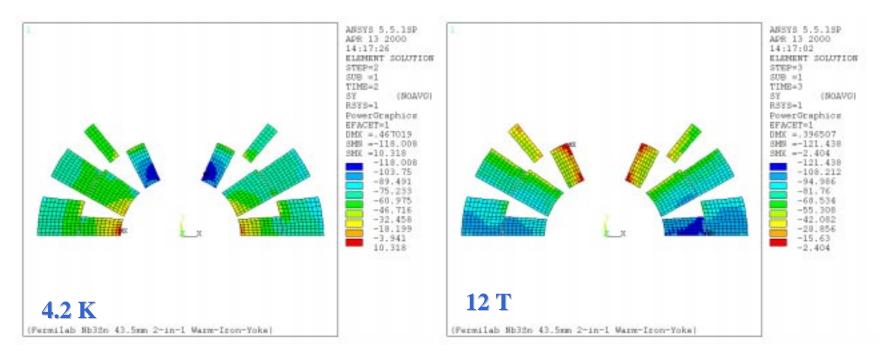
#### WARM Yoke Design: Stress Distribution





## Mechanical Analysis: 2 - in - 1 Design

#### WARM Yoke Design: Stress Distribution





## Summary

- Various magnet designs with the same coil block structure have been studied
- Mechanical Analysis has shown that the proposed 2 in 1 designs are feasible. Design Optimization is in Progress
- The proposed Coil Fabrication Technique has been successful implemented with good coil rigidity even after reaction.
- The Coil Impregnation and Magnet Assembly techniques are currently being tested on a practice coil and on a mechanical model respectively.
- The goal is to start testing the first dipole model by the end of August, 2000.



## Acknowledgments

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